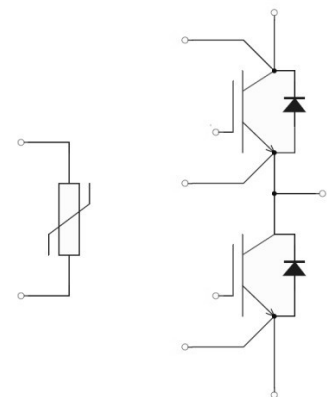
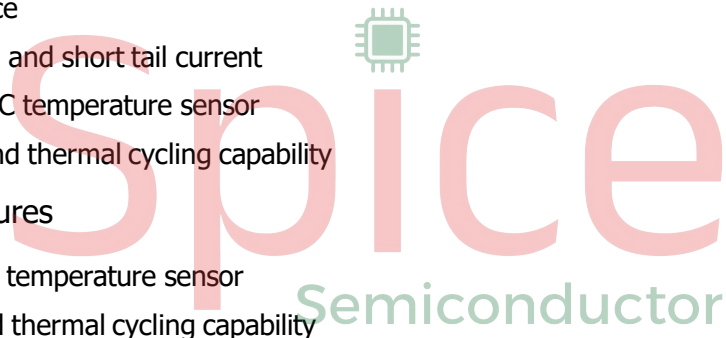


**IGBT - Field Stop, Trench, Soft Fast Recovery Diode**

**1700V/600A**

**Features**

- Electrical features
  - $V_{CES}=1700V$
  - $I_{C\ nom}=600A / I_{CRM}=1200A$
  - Low switching losses
  - Low inductance
  - Fast switching and short tail current
  - Integrated NTC temperature sensor
  - High power and thermal cycling capability
- Mechanical features
  - Integrated NTC temperature sensor
  - High power and thermal cycling capability
  - $Al_2O_3$  substrate with low thermal resistance
  - Copper base plate
- Potential Applications
  - Switching mode power supply
  - Drive inverters with brake system
  - Uninterruptible power supply
  - AC and DC servo drive amplifier



Device	Package	Shipping
SPM600V170D3HS	ED3	Tray

### IGBT, Inverter

#### Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{CES}$	1700	V
Continuous DC collector current	$T_C = 100^{\circ}\text{C}, T_{vj, max} = 150^{\circ}\text{C}$	$I_{C nom}$	600	A
Repetitive peak collector current	$t_P = 1 \text{ ms}$	$I_{CRM}$	1200	A
Total power dissipation	$T_C = 25^{\circ}\text{C}, T_{vj, max} = 175^{\circ}\text{C}$	$P_{tot}$	1595	W
Gate-emitter peak voltage		$V_{GES}$	+/- 20	V

#### Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$I_C = 600 \text{ A}, V_{GE} = 15 \text{ V}$	$V_{CE, sat}$		$T_{vj} = 25^{\circ}\text{C}$	1.72	V
				$T_{vj} = 125^{\circ}\text{C}$	2.12	V
				$T_{vj} = 150^{\circ}\text{C}$	2.23	V
Gate threshold voltage	$I_C = 3 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE, th}$	5.1	5.5	6.1	V
Gate charge	$V_{GE} = -15 \text{ V} \dots +15 \text{ V}$	$Q_G$		4.5		$\mu\text{C}$
Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$	$R_{Gint}$		3.60		$\Omega$
Input capacitance	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	$C_{ies}$		68.9		nF
Reverse transfer capacitance	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	$C_{res}$		2.9		nF
Collector-emitter cut-off current	$V_{CE} = 1700 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{CES}$			5	mA
Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{GES}$			300	nA
Turn-on delay time, inductive load	$I_C = 600 \text{ A}, V_{CE} = 900 \text{ V}$	$t_{d, on}$		$T_{vj} = 25^{\circ}\text{C}$	0.225	us
	$V_{GE} = +15/-15 \text{ V}$			$T_{vj} = 125^{\circ}\text{C}$	0.240	us
	$R_{G, on} = 3.3 \Omega$			$T_{vj} = 150^{\circ}\text{C}$	0.245	us
Rise time, inductive load	$I_C = 600 \text{ A}, V_{CE} = 900 \text{ V}$	$t_r$		$T_{vj} = 25^{\circ}\text{C}$	0.122	us
	$V_{GE} = +15/-15 \text{ V}$			$T_{vj} = 125^{\circ}\text{C}$	0.144	us
	$R_{G, on} = 3.3 \Omega$			$T_{vj} = 150^{\circ}\text{C}$	0.152	us

(table continues...)

Parameter	Note or test condition		Symbol	Values			Unit
				Min.	Typ.	Max.	
Turn-off delay time, inductive load	$I_C = 600A, V_{CE} = 900V$	$T_{vj} = 25^\circ C$	$t_{d,off}$		0.647		us
	$V_{GE} = +15/-15V$	$T_{vj} = 125^\circ C$			0.730		us
	$R_{G,off} = 3.3\Omega$	$T_{vj} = 150^\circ C$			0.743		us
Fall time, inductive load	$I_C = 600A, V_{CE} = 900V$	$T_{vj} = 25^\circ C$	$t_f$		0.202		us
	$V_{GE} = +15/-15V$	$T_{vj} = 125^\circ C$			0.193		us
	$R_{G,off} = 3.3\Omega$	$T_{vj} = 150^\circ C$			0.193		us
Turn-on energy loss per pulse	$I_C = 600A, V_{CE} = 900V, L_s = 35nH$	$T_{vj} = 25^\circ C$	$E_{on}$		55		mJ
	$V_{GE} = +15/-15V, di/dt = 3100A/\mu s$	$T_{vj} = 125^\circ C$			114		mJ
	$R_{G,on} = 3.3\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$			127		mJ
Turn-off energy loss per pulse	$I_C = 600A, V_{CE} = 900V, L_s = 35nH$	$T_{vj} = 25^\circ C$	$E_{off}$		131		mJ
	$V_{GE} = +15/-15V, dv/dt = 4500V/\mu s$	$T_{vj} = 125^\circ C$			157		mJ
	$R_{G,off} = 3.3\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$			167		mJ
SC data	$V_{GE} \leq 15V, V_{CC} = 900V, t_p \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$		$I_{sc}$		3000		A
Thermal resistance, junction to case	Per IGBT		$R_{th,jc}$			0.055	K/W

## Diode, Inverter

### Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage	$T_{vj} = 25^\circ C$	$V_{RRM}$	1700	V
Continuous DC forward current		$I_F$	600	A
Repetitive peak forward current	$t_p = 1ms$	$I_{FRM}$	1200	A

**Characteristic value**

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F = 600\text{ A}, V_{GE} = 0\text{ V}$	$V_F$		2.07		V
				2.31		V
				2.35		V
Peak reverse recovery current	$I_F = 600\text{ A}, V_R = 900\text{ V}$	$T_{vj} = 25^\circ\text{C}$	$I_{RM}$		636	A
	$V_{GE} = -15\text{ V}, -di_F/dt = 3100\text{ A}/\mu\text{s}$	$T_{vj} = 125^\circ\text{C}$			627	A
	( $T_{vj}=150^\circ\text{C}$ )	$T_{vj} = 150^\circ\text{C}$			617	A
Recovered charge	$I_F = 600\text{ A}, V_R = 900\text{ V}$	$T_{vj} = 25^\circ\text{C}$	$Q_r$		128	$\mu\text{C}$
	$V_{GE} = -15\text{ V}, -di_F/dt = 3100\text{ A}/\mu\text{s}$	$T_{vj} = 125^\circ\text{C}$			164	$\mu\text{C}$
	( $T_{vj}=150^\circ\text{C}$ )	$T_{vj} = 150^\circ\text{C}$			173	$\mu\text{C}$
Reverse recovery energy	$I_F = 600\text{ A}, V_R = 900\text{ V}$	$T_{vj} = 25^\circ\text{C}$	$E_{rec}$		86	mJ
	$V_{GE} = -15\text{ V}, -di_F/dt = 3100\text{ A}/\mu\text{s}$	$T_{vj} = 125^\circ\text{C}$			107	mJ
	( $T_{vj}=150^\circ\text{C}$ )	$T_{vj} = 150^\circ\text{C}$			117	mJ
Thermal resistance, junction to case	Per diode	$R_{thJC}$			0.1	K/W

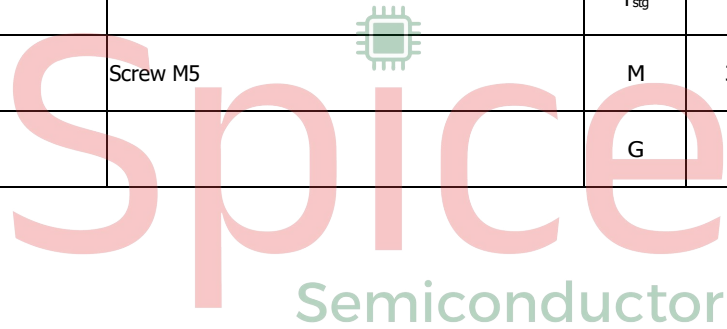
**NTC-Thermistor**
**Characteristic value**

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	$T_C = 25^\circ\text{C}$	$R_{25}$		5.00		K $\Omega$
Power dissipation	$T_C = 25^\circ\text{C}$	$P_{25}$			20	mW
B-value B-Z	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298, 15\text{K}))]$	$B_{25}/B_{50}$		3375		K
B-value B-Z	$R_2 = R_{25} \exp[B_{25/75}(1/T_2 - 1/(298, 15\text{K}))]$	$B_{25}/B_{75}$		3408		K
B-value B-Z	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298, 15\text{K}))]$	$B_{25}/B_{100}$		3436		K

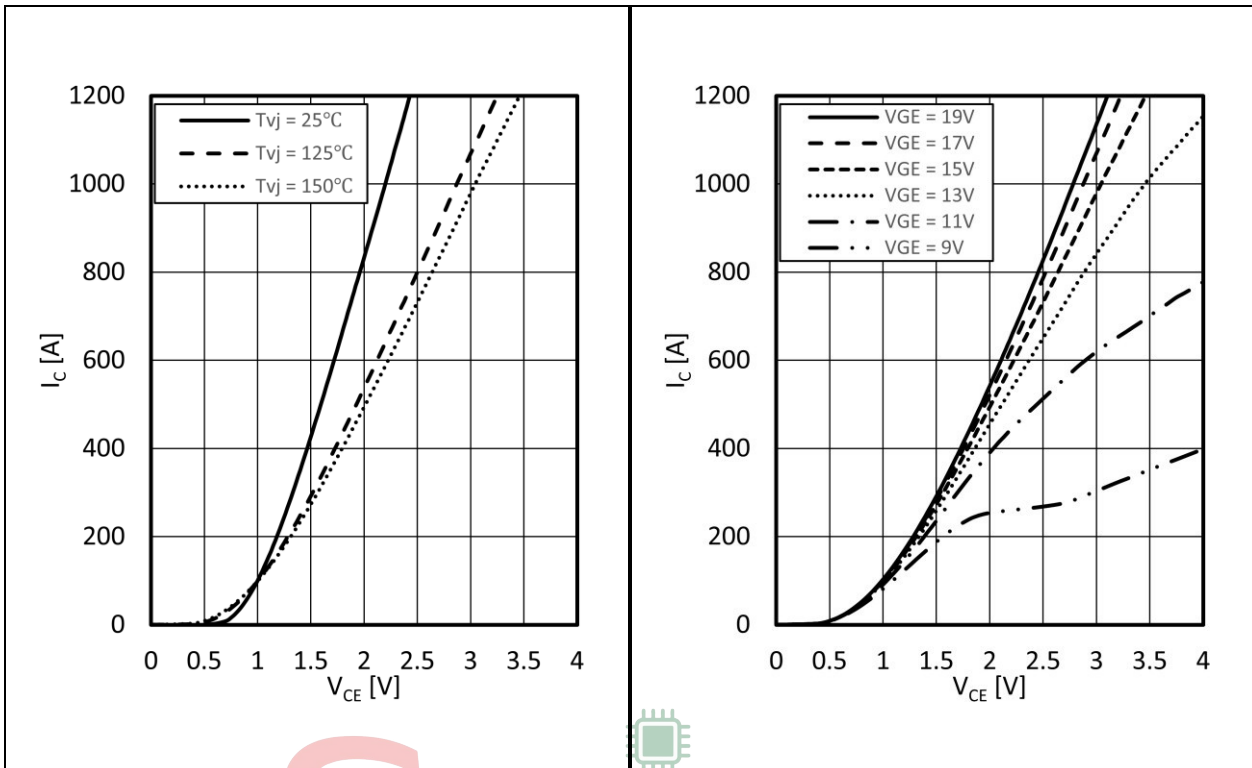
## Module

### Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage	RMS, f=50HZ,1min	$V_{ISOL}$			3400	V
Stray inductance module		$L_{sCE}$		35		nH
Operation Junction Temperature		$T_{jop}$	-40		150	°C
Storage Temperature Range		$T_{stg}$	-40		125	°C
Mounting Torque	Screw M5	M	3		6	N.m
Weight of Module		G		350		g



**Characteristics diagrams**

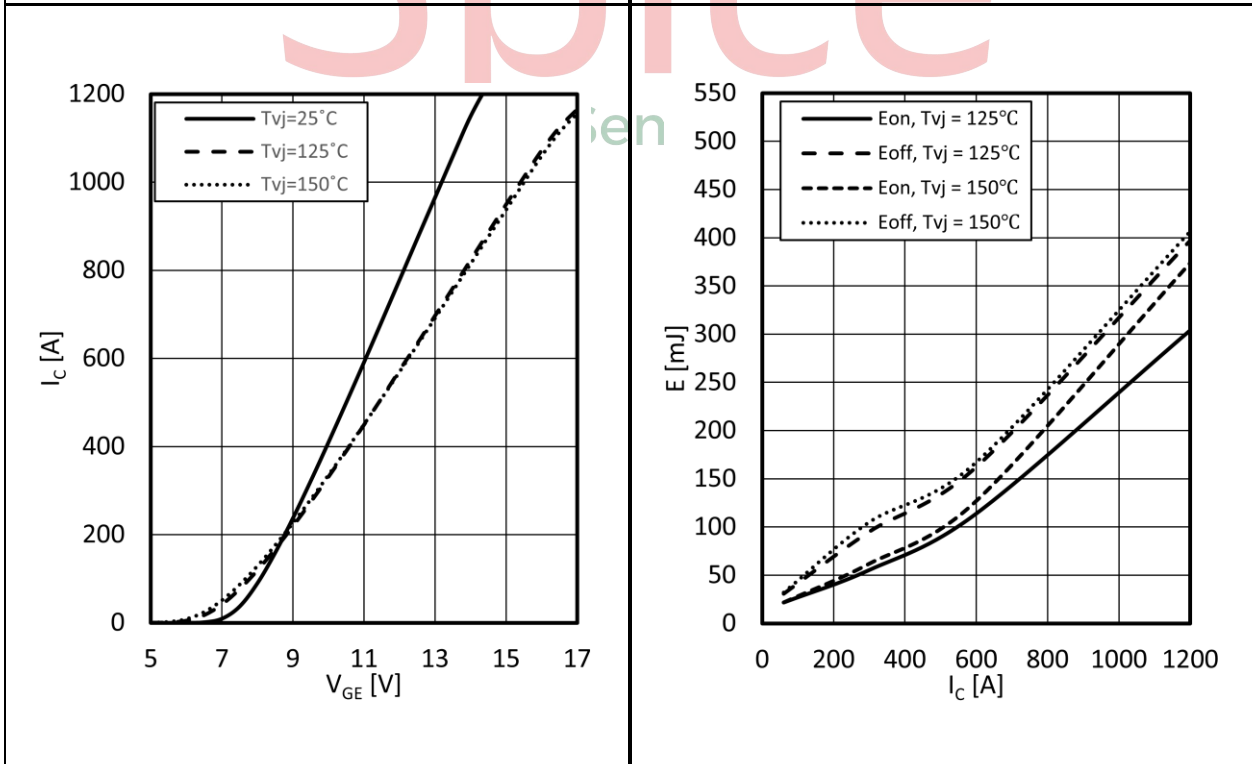


**Output characteristic IGBT, Inverter (typical)**

$I_C = f(V_{CE})$   $V_{GE} = 15V$

**Output characteristic IGBT, Inverter (typical)**

$I_C = f(V_{CE})$   $T_{vj} = 150^\circ C$

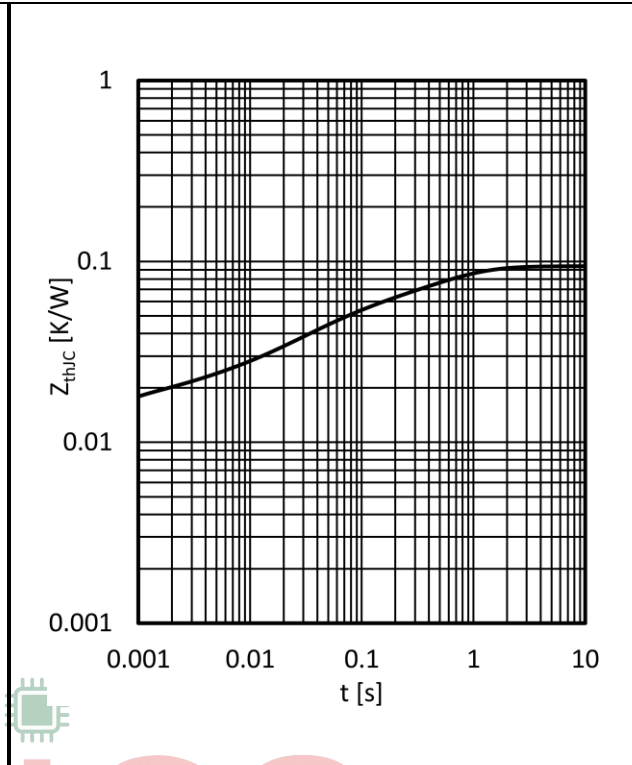
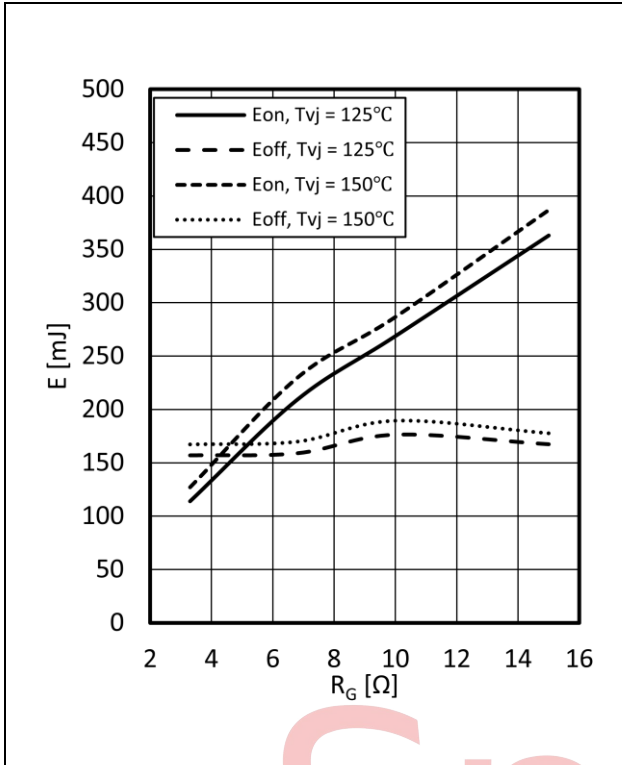


**Transfer characteristic IGBT, Inverter (typical)**

$I_C = f(V_{GE})$   $V_{CE} = 20V$

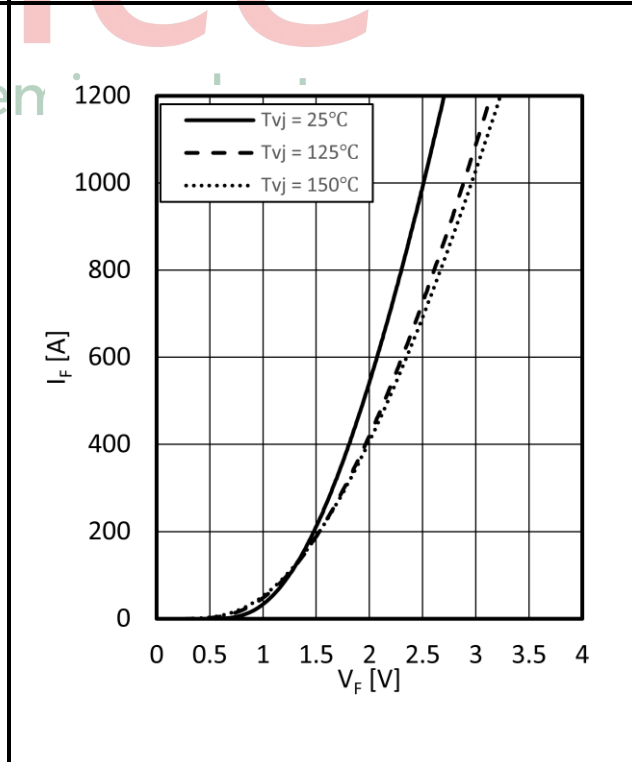
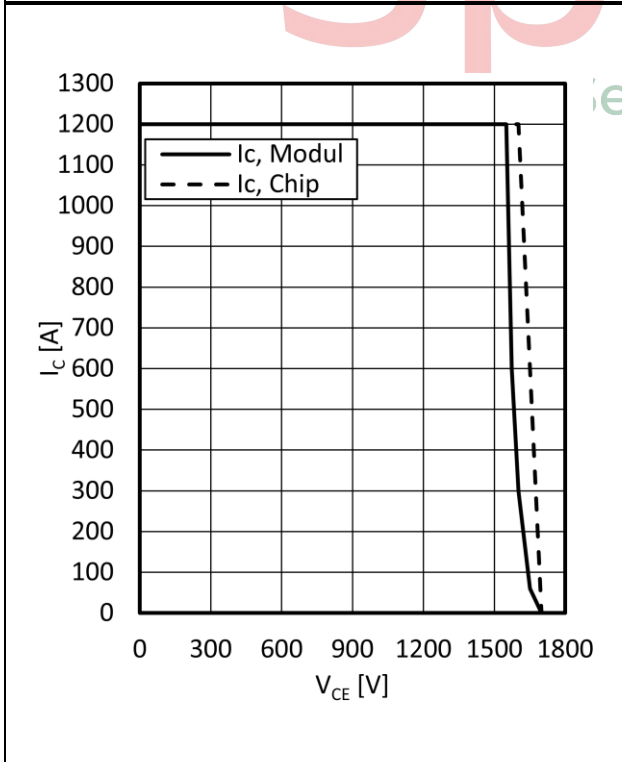
**Switching losses IGBT, Inverter (typical)**

$E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$   $V_{GE} = \pm 15V$ ,  $R_{Gon} = 3.3 \Omega$   $R_{Goff} = 3.3 \Omega$ ,  $V_{CE} = 900V$



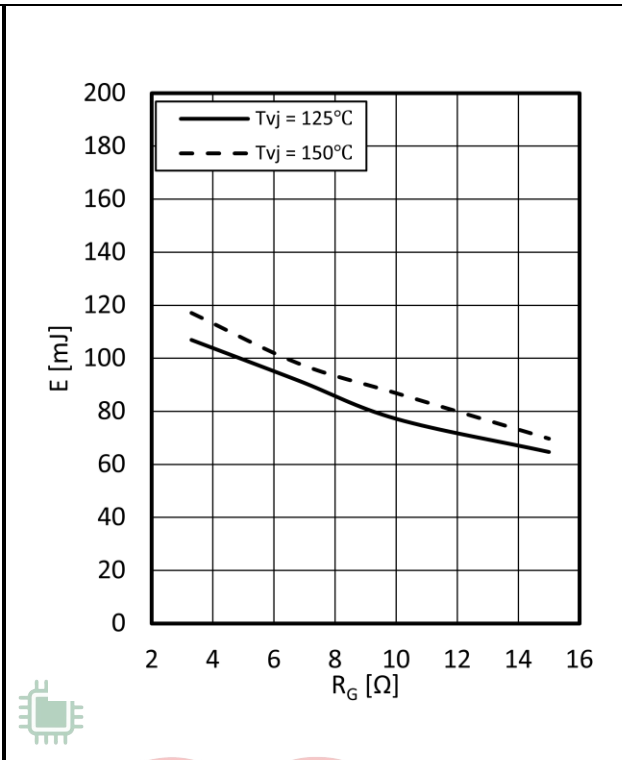
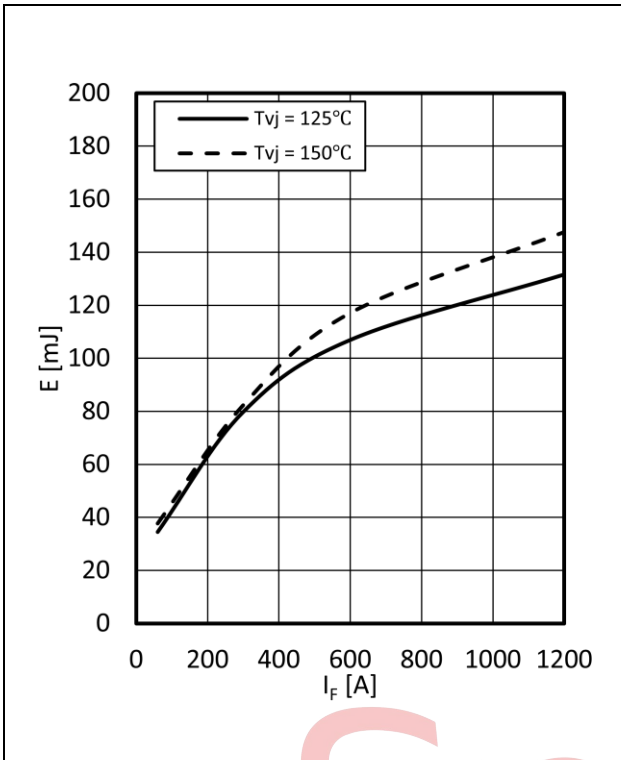
**Switching losses IGBT, Inverter (typical)**  
 $E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   $V_{GE} = \pm 15V$ ,  $I_C = 600A$ ,  $V_{CE} = 900V$

**Transient thermal impedance IGBT, Inverter**  
 $Z_{thJC} = f(t)$



**Reverse bias safe operating area IGBT, Inverter (RBSOA)**  
 $I_C = f(V_{CE})$   $V_{GE} = \pm 15V$   $R_{Goff} = 3.3\Omega$ ,  $T_{vj} = 150^\circ C$

**Forward characteristic of Diode, Inverter (typical)**  
 $I_F = f(V_F)$

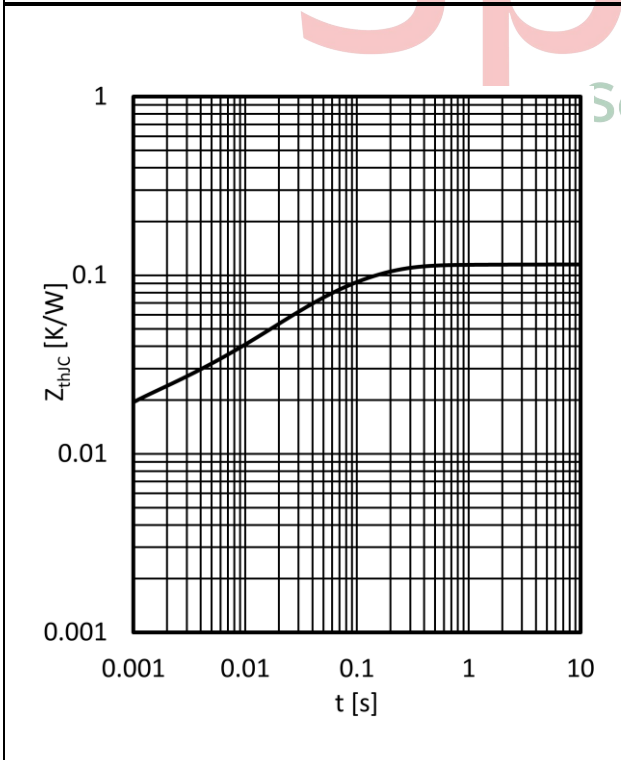


**Switching losses Diode, Inverter (typical)**

$E_{rec} = f(I_F) R_{Gon} = 3.3 \Omega, V_{CC} = 900V$

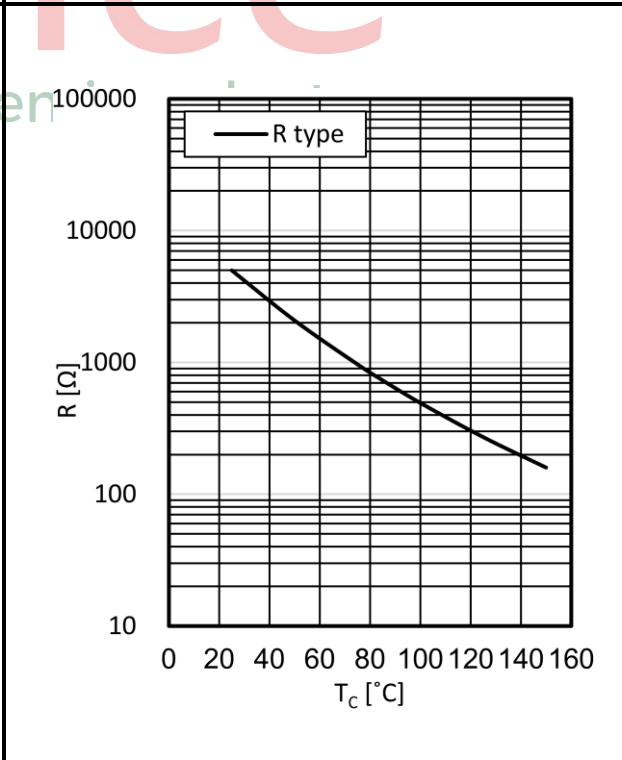
**Switching losses Diode, Inverter (typical)**

$E_{rec} = f(R_G) I_F = 600 A, V_{CC} = 900V$



**Transient thermal impedance Diode Inverter**

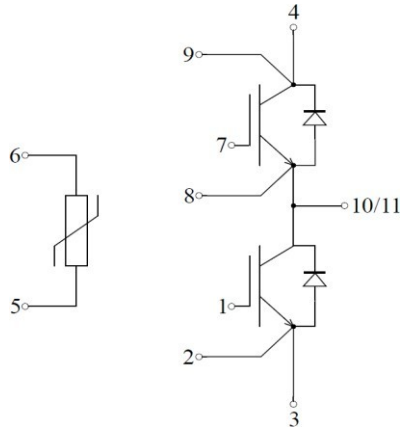
$Z_{thjC} = f(t)$



**NTC-Thermistor-temperature characteristic (typical)**

$R=f(T)$

**Circuit Diagram**



**Package Outlines**

